SiR4606DP

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Vishay Siliconix

RoHS COMPLIANT

HALOGEN

FREE



PRODUCT SUMMARY V_{DS} (V) 60 0.0185 $R_{DS(on)}$ max. (Ω) at V_{GS} = 10 V $R_{DS(on)}$ max. (Ω) at V_{GS} = 7.5 V 0.0225 Q_a typ. (nC) 6.9 I_D (A) ^{a, f} 16 Configuration Single

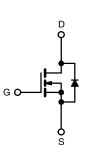
FEATURES

N-Channel 60 V (D-S) MOSFET

- TrenchFET[®] Gen IV power MOSFET
- Tuned for the lowest R_{DS} Q_{oss} FOM
- 100 % R_q and UIS tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- · Primary side switch
- Synchronous rectification
- DC/DC converter
- Motor drive switch
- Boost converter
- LED backlighting



N-Channel MOSFET

ORDERING INFORMATIO	N
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Package	PowerPAK SO-8		
Lead (Pb)-free and halogen-free	SiR4606DP-T1-GE3		

PARAMETER		SYMBOL	LIMIT	UNIT
Drain-source voltage		V _{DS}	60	
Gate-source voltage		V _{GS}	± 20	V
	T _C = 25 °C		16 ^a	
Continuous drain current ($T_J = 150 \text{ °C}$) Pulsed drain current (t = 100 µs)	T _C = 70 °C		16 ^a	
	T _A = 25 °C	I _D	10.5 ^{b, c}	
	T _A = 70 °C	1	8.4 ^{b, c}	
		I _{DM}	40	— A
	T _C = 25 °C		16 ^a	
Continuous source-drain diode current	T _A = 25 °C	I _S	2.6 ^{b, c}	
Single pulse avalanche current		I _{AS}	12	
Single pulse avalanche energy	L = 0.1 mH	E _{AS}	7.2	mJ
	T _C = 25 °C		31.2	
Maximum power dissipation	T _C = 70 °C		20	244
	T _A = 25 °C	P _D	3.7 ^{b, c}	W
	T _A = 70 °C	1	2.4 ^{b, c}	
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +150	
Soldering recommendations (peak tempera	ture) ^{d, e}	Ŭ	260	°C

Notes

a. Package limited

b. Surface mounted on 1" x 1" FR4 board

c. t = 10 s

d. See solder profile (www.vishay.com/doc?73257). The PowerPAK 1212-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection

e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components

f. T_C = 25 °C

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THERMAL RESISTANCE RATINGS PARAMETER SYMBOL TYPICAL MAXIMUM UNIT Maximum junction-to-ambient a, b $t \le 10 s$ 26 34 **R**thJA °C/W Maximum junction-to-case (drain) Steady state 2.9 4 R_{thJC}

Notes

a. Surface mounted on 1" x 1" FR4 board

b. Maximum under steady state conditions is 70 °C/W

PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-source breakdown voltage	V _{DS}	V _{GS} = 0 V, I _D = 250 μA	60	-	-	V	
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$		-	35	-	mV/°C	
V _{GS(th)} temperature coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA	-	-7.1	-		
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \ \mu A$	2	-	4	V	
Gate-source leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$	-	-	100	nA	
Zero gate voltage drain current		$V_{DS} = 60 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	1		
	I _{DSS}	V _{DS} = 60 V, V _{GS} = 0 V, T _J = 70 °C	-	-	10	- μΑ	
On-state drain current ^a	I _{D(on)}	$V_{DS} \ge 10 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	10	-	-	А	
Drain-source on-state resistance ^a		V _{GS} = 10 V, I _D = 4 A	-	0.0142	0.0185	Ω	
	R _{DS(on)}	$V_{GS} = 7.5 \text{ V}, \text{ I}_{D} = 4 \text{ A}$	-	0.0166	0.0225		
Forward transconductance a	g _{fs}	V _{DS} = 15 V, I _D = 10 A	-	25	-	S	
Dynamic ^b			I		•		
Input capacitance	C _{iss}		-	540	-	pF	
Output capacitance	C _{oss}	V _{DS} = 30 V, V _{GS} = 0 V, f = 1 MHz	-	150	-		
Reverse transfer capacitance	C _{rss}		-	11	-		
		$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 10 \text{ V}, \text{ I}_{D} = 4 \text{ A}$	-	8.9	13.5	nC	
Total gate charge	Qg	$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 7.5 \text{ V}, \text{ I}_{D} = 4 \text{ A}$	-	6.9	10.5		
Gate-source charge	Q _{qs}		-	2.5	-		
Gate-drain charge	Q _{gd}		-	1.8	-		
Output charge	Q _{oss}	$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	9	-		
Gate resistance	R _q	f = 1 MHz	0.3	1.3	2.6	Ω	
Turn-on delay time	t _{d(on)}		-	10	20	-	
Rise time	tr	$V_{DD} = 30 \text{ V}, \text{ R}_{\text{I}} = 7.5 \Omega, \text{ I}_{\text{D}} \cong 4 \text{ A},$	-	5	10		
Turn-off delay time	t _{d(off)}	$V_{GEN} = 10 \text{ V}, \text{ R}_{g} = 1 \Omega$	-	14	30		
Fall time	t _f		-	5	10		
Turn-on delay time	t _{d(on)}		-	10	20	ns	
Rise time	t _r	$V_{DD} = 30 \text{ V}, \text{ R}_{L} = 7.5 \Omega, \text{ I}_{D} \cong 4 \text{ A},$	-	5	10		
Turn-off delay time	t _{d(off)}	$V_{\text{GEN}} = 7.5 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$	-	12	25		
Fall time	t _f		-	5	10		
Drain-Source Body Diode Characterist	cs						
Continuous source-drain diode current	I _S	$T_{C} = 25 \ ^{\circ}C$	-	-	16	۸	
Pulse diode forward current	I _{SM}		-	-	40	A	
Body diode voltage	V _{SD}	$I_{S} = 4 \text{ A}, V_{GS} = 0 \text{ V}$	-	0.85	1.2	V	
Body diode reverse recovery time	t _{rr}		-	38	75	ns	
Body diode reverse recovery charge	Q _{rr}	1	-	23	45	nC	
Reverse recovery fall time	t _a	$I_F = 4 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 \ ^\circ\text{C}$	-	17	-	ns	
Reverse recovery rise time	t _b		-	21	- 1		

Notes

a. Pulse test; pulse width $\leq 300~\mu s,~duty~cycle \leq 2~\%$

b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

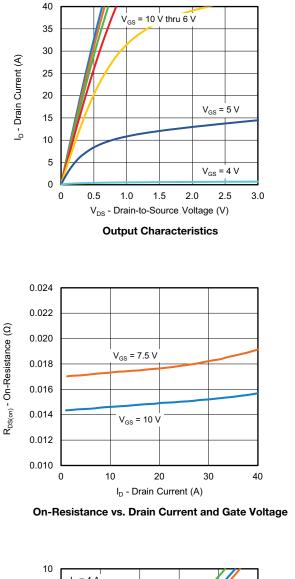
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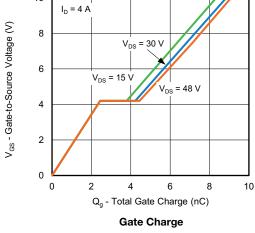


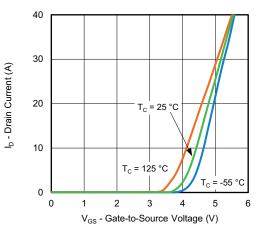
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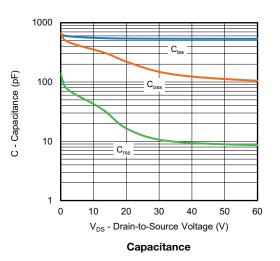
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

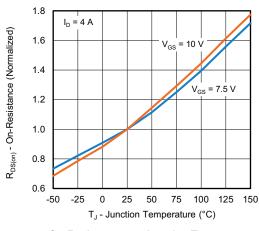






Transfer Characteristics





On-Resistance vs. Junction Temperature

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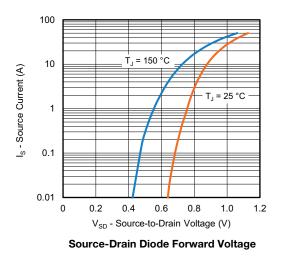
3 For technical questions, contact: <u>pmostechsupport@vishay.com</u> Document Number: 63129

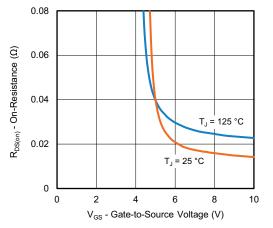
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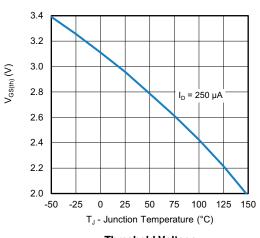
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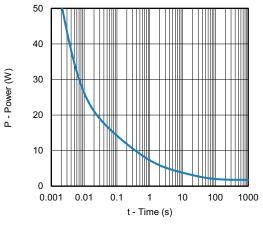




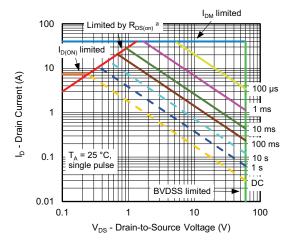
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



Single Pulse Power, Junction-to-Ambient



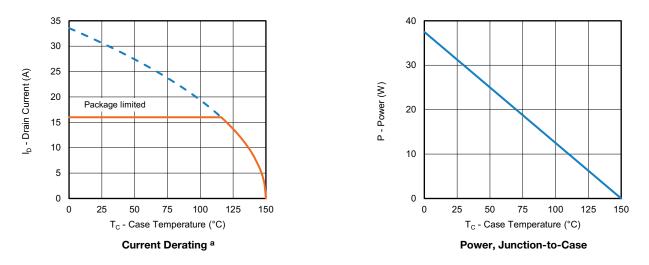
Safe Operating Area, Junction-to-Ambient



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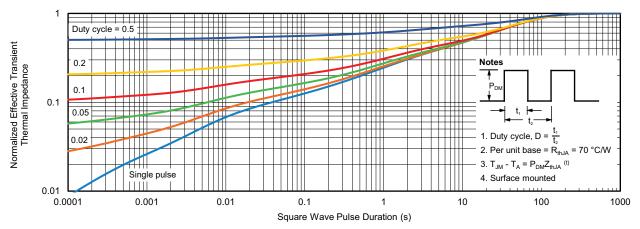
Note

a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

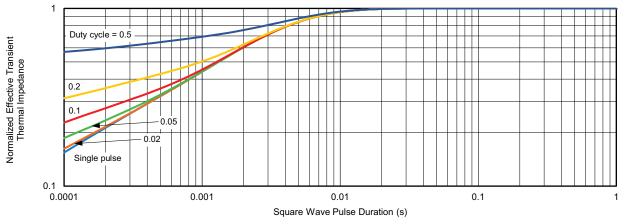


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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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